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SEMICONDUCTOR®

November 2013

FQI4N90

N-Channel QFET® MOSFET

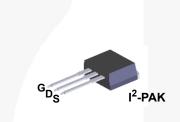
900 V, 4.2 A, 3.3 Ω

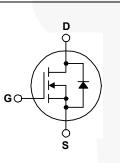
Description

This N-Channel enhancement mode power MOSFET is • 4.2 A, 900 V, $R_{DS(on)}$ = 3.3 Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state D = 2.1 A Low Gate Charge (Typ. 24 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 9.5 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- $I_{D} = 2.1 \text{ A}$





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

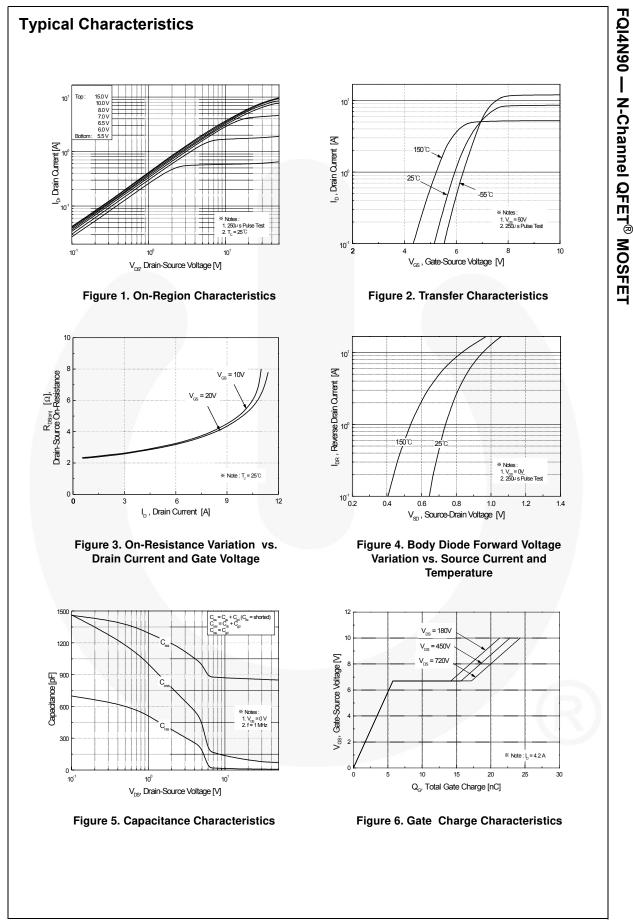
Symbol	Parameter	FQI4N90TU	Unit	
V _{DSS}	Drain-Source Voltage	900	V	
I _D	Drain Current - Continuous (T _C = 25°C)	4.2	A	
	- Continuous (T _C = 100°C)	2.65	A	
I _{DM}	Drain Current - Pulsed (Not	e 1) 16.8	A	
V _{GSS}	Gate-Source Voltage	± 30	V	
E _{AS}	Single Pulsed Avalanche Energy (Not	ulsed Avalanche Energy (Note 2) 570		
I _{AR}	Avalanche Current (Not	e 1) 4.2	A	
E _{AR}	Repetitive Avalanche Energy (Not	e 1) 14	mJ	
dv/dt	Peak Diode Recovery dv/dt (Not	e 3) 4.0	V	
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$	3.13	W	
	Power Dissipation $(T_C = 25^{\circ}C)$	140	W	
	- Derate above 25°C	1.12	W/°C	
T _J , T _{stg}	Operating and Storage Temperature Range	-55 to +150	°C	
TL	Maximum lead temperature for soldering, 1/8" from case for 5 seconds.	300	°C	

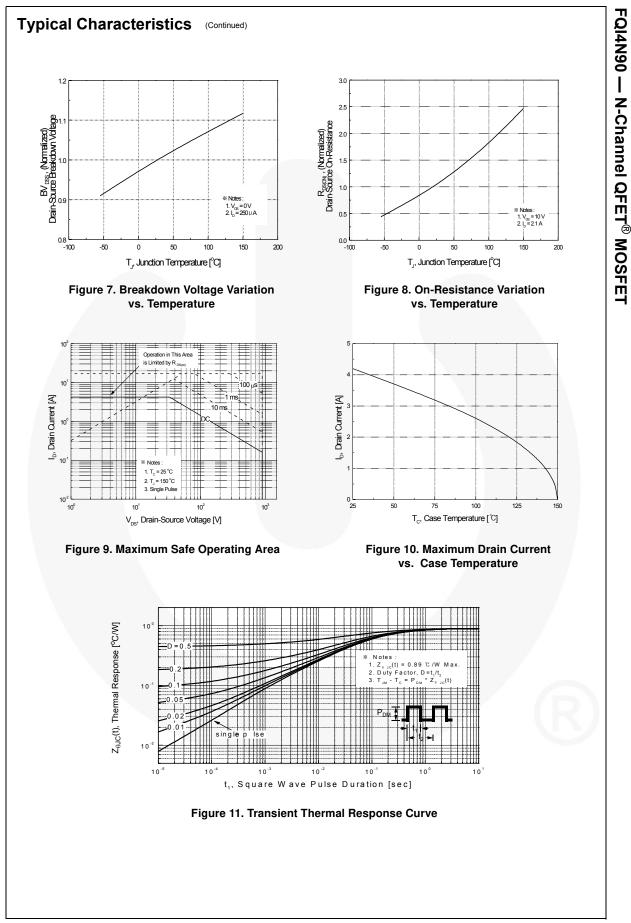
Thermal Characteristics

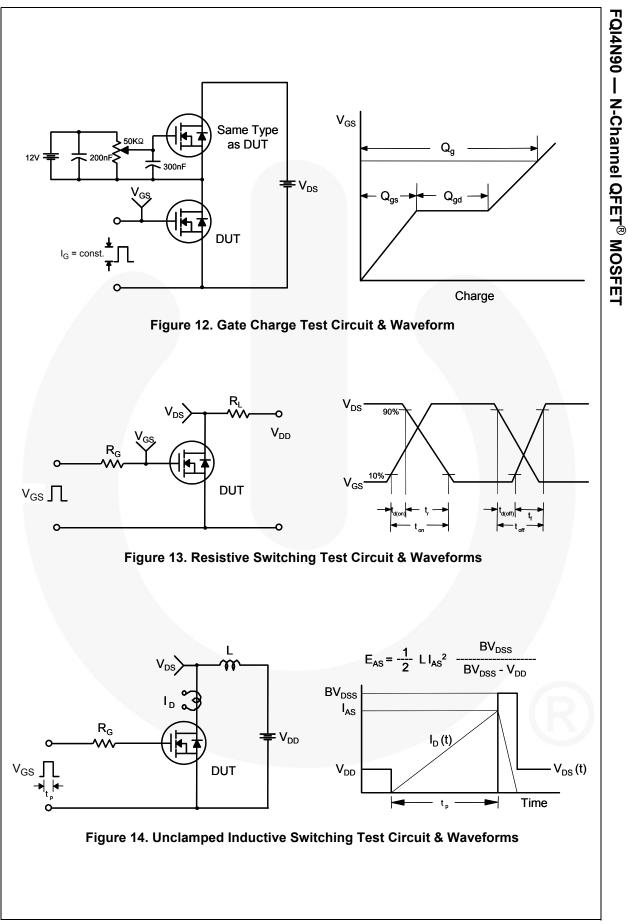
Symbol	Parameter	FQI4N90TU	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	0.89	
Б	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40	

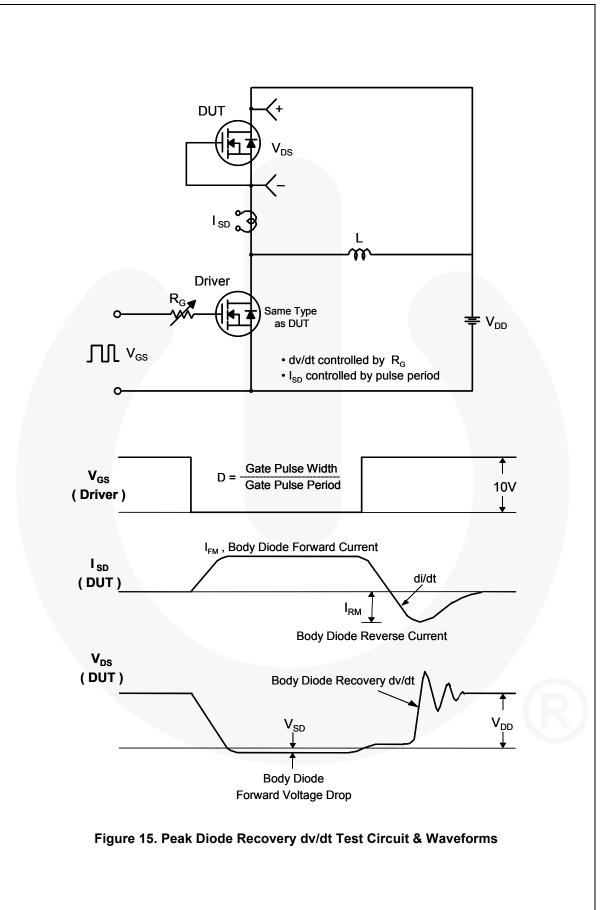
FQI4	umber	Top Mark	Pack	0 0		el Size	Tape W	idth	Quantity 50 units	
	V90TU	FQI4N90	I ² -P				N/A	N/A		
lectric	al Cha	racteristics	T _C = 25°0	C unless ot	nerwise noted.					
Symbol			Test Conditions		Min.	Тур.	Max.	. Unit		
Off Cha	racterist	ics								
BV _{DSS}	Drain-Sou	rce Breakdown Volta	age	V _{GS} = 0 V, I _D = 250 μA			900			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$			с	0.9		V/°C	
I _{DSS}	Zero Gate Voltage Drain Current		$V_{DS} = 900 \text{ V}, V_{GS} = 0 \text{ V}$				10	μA		
				$V_{DS} = 720 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$					100	μA
I _{GSSF}		/ Leakage Current, I			$30 \text{ V}, \text{V}_{\text{DS}} = 0 \text{ V}$	/			100	nA
I _{GSSR}	Gate-Body	y Leakage Current, I	Reverse	V _{GS} =	-30 V, V _{DS} = 0 V	/			-100	nA
	racterist									
V _{GS(th)}		Gate Threshold Voltage		$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$			3.0		5.0	V
R _{DS(on)}	Static Drai On-Resist			V _{GS} =	10 V, I _D = 2.1 A			2.7	3.3	Ω
9 _{FS}	Forward T	ransconductance		V _{DS} =	50 V, I _D = 2.1 A			3.5		S
		cteristics						1	1	
C _{iss}	Input Capa		_	V _{DS} =	25 V, V _{GS} = 0 V,			860	1100	pF
C _{oss}	Output Capacitance Reverse Transfer Capacitance		f = 1.0 MHz			90	120	pF		
C _{rss}							9.5	12.5	pF	
Switchi	ng Chara	acteristics								
t _{d(on)}	Turn-On D	elay Time		Vnn =	V _{DD} = 450 V, I _D = 4.2 A,			25	60	ns
t _r	Turn-On R	Rise Time		$R_G = 2$	_	.,		70	150	ns
t _{d(off)}	Turn-Off D	elay Time		U				45	100	ns
t _f	Turn-Off F	all Time				(Note	4)	40	90	ns
Qg	Total Gate	Charge		V _{DS} =	720 V, I _D = 4.2 A	۹,		24	30	nC
Q _{gs}	Gate-Sour	ce Charge		V _{GS} =	10 V			5.8		nC
Q _{gd}	Gate-Drain	n Charge				(Note	4)	11.5		nC
Drain-S	ource Di	ode Characteri	stics a	nd Max	cimum Ratin	gs				
I _S	Maximum	Continuous Drain-S	ource Dic	de Forw	ard Current				4.2	Α
I _{SM}	Maximum	Pulsed Drain-Sourc	e Diode F	orward	Current				16.8	Α
V _{SD}	Drain-Sou	rce Diode Forward	Voltage	age $V_{GS} = 0 V, I_S = 4.2 A$				1.4	V	
t _{rr}	Reverse F	Recovery Time		V _{GS} =	0 V, I _S = 4.2 A,			440		ns
	Deverae F	Recovery Charge		dl _F / dt = 100 A/μs			3.3		μC	

FQI4N90 — N-Channel QFET[®] MOSFET









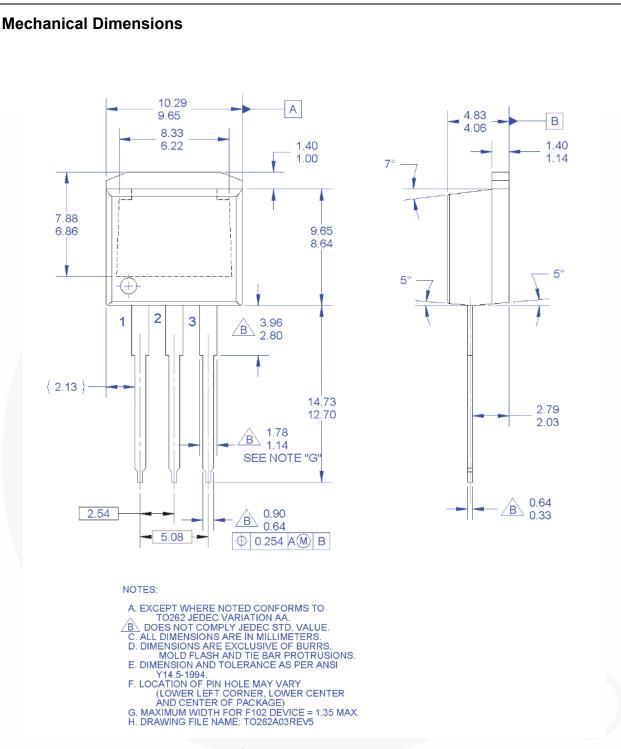


Figure 16. TO262 (I²PAK), Molded, 3-Lead, Jedec Variation AA

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QI4N90 —

N-Channel QFET[®] MOSFE

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